

# **DS1682** DALLAS Total-Elapsed-Time Recorder with Alarm

#### www.maxim-ic.com

## **GENERAL DESCRIPTION**

The DS1682 is an integrated elapsed-time recorder containing factory-calibrated, temperaturecompensated RC time base that eliminates the need for an external crystal. Using EEPROM technology to maintain data in the absence of power, the DS1682 requires no backup power source. The DS1682 detects and records the number of events on the EVENT pin and the total cumulative event time since the DS1682 was last reset to 0. The ALARM pin alerts the user when the total time accumulated equals the user-programmed alarm value. The polarity of the open-drain ALARM pin can be programmed to either drive low or to become high impedance upon an alarm condition. The DS1682 is ideal for applications that monitor the total amount of time that a device has been in operation and/or the number of uses since inception of service, repair, or the last calibration.

## **APPLICATIONS**

High-Temp, Rugged, Industrial Applications Where Vibration or Shock Could Damage a Quartz Crystal

Any System Where Time-of-Use is Important (Warranty Tracking)

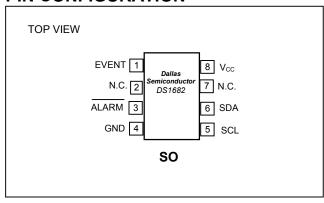
## ORDERING INFORMATION

PART	TEMP RANGE	PIN-PACKAGE
DS1682S	-40°C to +85°C	8 SO (150 mil)

# **FEATURES**

- Records the Total Time that the Event Input has Been Active and the Number of Events that have Occurred
- 32-Bit. Nonvolatile. Elapsed Time Counter (ETC) Monitors Event Duration with Quarter-Second Resolution and Provides 34 Years of Total Time Accumulation
- Programmable Elapsed Time ALARM Output
- Nonvolatile 17-Bit Event Counter Records the Total Number of Times an Event has Occurred
- Calibrated, Temperature-Compensated RC Time Base Accurate to 2% Typical
- 10 Bytes of EEPROM User Memory
- Write Disable Function to Prevent the Memory from Being Changed or Erased
- 2-Wire Serial Communication
- Wide 2.5V to 5.5V Power-Supply Range
- Useful in Time-of-Use Warranty, Calibration. Repair, and Maintenance Applications

#### PIN CONFIGURATION



Note: Some revisions of this device may incorporate deviations from published specifications known as errata. Multiple revisions of any device may be simultaneously available through various sales channels. For information about device errata, click here: www.maxim-ic.com/errata.

> 1 of 12 RFV: 032703

## **ABSOLUTE MAXIMUM RATINGS**

Voltage Range on Any Pin Relative to Ground Operating Temperature Range Storage Temperature Range Soldering Temperature -0.3V to +6V -40°C to +85°C -55°C to +125°C See IPC/JEDEC J-STD-020A specification

This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time can affect reliability.

# RECOMMENDED DC OPERATING CONDITIONS

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Power-Supply Voltage	V <sub>cc</sub>		2.5		5.5	V
Input Trip Point	V <sub>ETP</sub>		0.3 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.7 x V <sub>CC</sub>	V
Event Trip-Point Hysteresis	V <sub>HYS</sub>		1% of V <sub>CC</sub>			%

## DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 2.5V \text{ to } 5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Leakage	ILI		-1		+1	μΑ
ALARM Output (I <sub>OL</sub> = 10mA)	V <sub>OL</sub>				0.8	V
SDA Output (I <sub>OL</sub> = 4mA)	$V_{OL}$				0.8	V
Active Supply Current (Event Active)	I <sub>CCA</sub>	(Note 1)		120	300	μΑ
Standby Current	1	V <sub>CC</sub> = 5.5V		6	15	^
(Event Inactive) (Note 1)	Iccs	V <sub>CC</sub> = 3.0V		2	4	μΑ
EEPROM Write Current	I <sub>EE</sub>	(Note 1)		150	300	μΑ

## **EVENT TIMING**

 $(V_{CC} = 2.5V \text{ to } 5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Time Event Minimum	t <sub>G</sub>	(Note 1)	10	35	70	ms
Time Event Start	t <sub>ES</sub>	(Note 1)	112	125	137	ms
Time Event Increment	t <sub>El</sub>	(Note 1)	237.5	250	262.5	ms
Time Event Max	t <sub>EM</sub>				34	years

#### AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 2.5V \text{ to } 5.5V. T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C.})$ 

$(V_{CC} = 2.5V \text{ to } 5.5V, I_A = -40^{\circ})$	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
EEPROM Endurance	E <sub>E</sub>	(Note 2)			50k	writes
EEPROM Write Time	t <sub>EW</sub>	(Notes 1, 3, 4)		150	300	ms
EEPROM Transfer to RAM	t <sub>ER</sub>	(Notes 1, 5)		1		ms
ALARM Output Active-Low Pulse Width	t <sub>SL</sub>	(Note 1)		62.5		ms
ALARM Output Active-High Pulse Width	t <sub>SH</sub>	(Note 1)		437.5		ms
ALARM Input Pulled Low and Released Pulse Width	t <sub>SPL</sub>	(Note 1)		500		ms
SCL Clock Frequency	$f_{SCL}$	Fast mode			400	kHz
, ,	ISCL	Standard mode			100	IXI IZ
Bus Free Time Between a		Fast mode	1.3			
STOP and START Condition	t <sub>BUF</sub>	Standard mode	4.7			μS
Hold Time (Repeated)	+	Fast mode	0.6			
START Condition (Note 6)	t <sub>HD:STA</sub>	Standard mode	4.0			μS
10,44,5 : 1,600,		Fast mode	1.3			
LOW Period of SCL	$t_LOW$	Standard mode	4.7			μS
		Fast mode	0.6			
HIGH Period of SCL	t <sub>HIGH</sub>	Standard mode	4.0		μS	
Setup Time for a Repeated		Fast mode	0.6			
START	t <sub>SU:STA</sub>	Standard mode	4.7			μS
Data Hald Time (Nata 7 0)	1	Fast mode	0			_
Data Hold Time (Notes 7, 8)	t <sub>HD:DAT</sub>	Standard mode	0			μS
5 ( 0 ( 7) (1) ( 0)		Fast mode	100			
Data Setup Time (Note 9)	t <sub>SU:DAT</sub>	Standard mode	250			ns
Rise Time of SDA and SCL		Fast Mode	20 + 0.1C <sub>B</sub>		300	
Signals (Note 10)	t <sub>R</sub>	Standard mode	20 + 0.1C <sub>B</sub>		1000	ns
Fall Time of SDA and SCL	4	Fast mode	20 + 0.1C <sub>B</sub>		300	200
Signals (Note 10)	t <sub>F</sub>	Standard mode	20 + 0.1C <sub>B</sub>		300	ns
Cotun Time for CTOD	4	Fast mode	0.6			
Setup Time for STOP	t <sub>su:sto</sub>	Standard mode	4.0			μS
Input Capacitance (Note 1)	C <sub>I/O</sub>			10		pF
Capacitive Load for Each Bus Line (Note 10)	Св				400	pF

- Note 1: Typical values are at  $+25^{\circ}$ C,  $V_{CC}$  = 4.0V. Note 2: The elapsed time and event counters are backed by three EEPROM arrays, which are used sequentially, allowing up to 3 x E<sub>E</sub>. The configuration register, alarm trip-point register and user memory use a single array, limiting them to one E<sub>E</sub>.
- Note 3: A decoupling capacitor to supply high instantaneous currents during EEPROM writes is recommended. A typical value is 0.01µF. Vcc must be maintained above  $V_{CC}$  minimum, including transients, during EEPROM writes.

  Note 4:  $V_{CC}$  must be at or above 2.5V for  $t_{EW}$  after the end of an event to insure data transfer to the EEPROM.
- Note 5: Reading data while the contents of EEPROM are transferred to RAM results in incorrect reads.
- Note 6: After this period, the first clock pulse is generated.
- Note 7: A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the VIHMIN of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.
- Note 8: The maximum t<sub>HD:DAT</sub> has only to be met if the device does not stretch the low period (t<sub>LOW</sub>) of the SCL signal.

Note 9: A fast mode device can be used in a standard mode system, but the requirement  $t_{SU:DAT} \ge 250$ ns must be met. This is automatically the case if the device does not stretch the  $t_{LOW}$ . If such a device does stretch  $t_{LOW}$ , it must output the next data bit to the SDA line  $t_R$  max +  $t_{SU:DAT} = 1000 + 250 = 1250$ ns before the SCL line is released.

Note 10: C<sub>B</sub>—total capacitance of one bus line in pF.

Figure 1. Timing Diagram

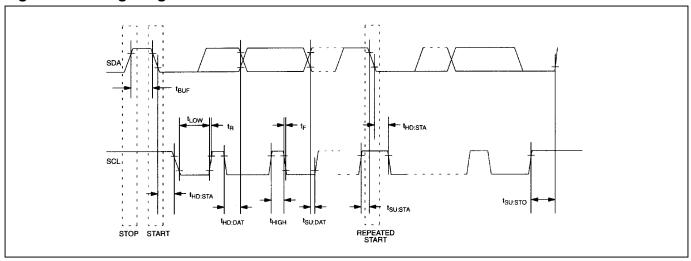


Figure 2 shows the DS1682 measuring total run time and operating from a battery with the alarm tied to an LED and a pushbutton switch to trigger the alarm output.

Figure 2. Total Run Time

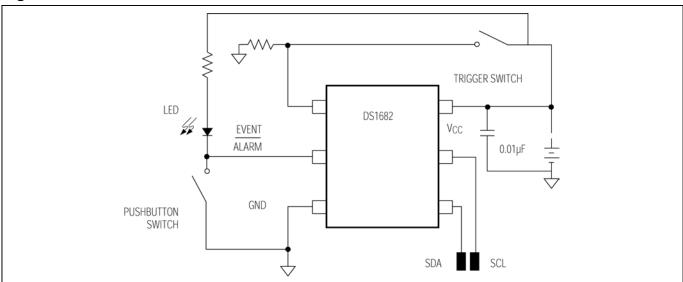


Figure 3 shows the DS1682 in a total time-of-use application where power may be removed at the same time as the end of the event. The  $V_{CC}$  slew rate at power-down is fast with respect to  $t_{EW}$ . A capacitor maintains  $V_{CC}$  on the DS1682 above 2.5V until the EEPROM write completes. A Schottky diode blocks current from the capacitor to other devices connected to  $V_{CC}$ .

The  $V_{CC}$  holding capacitor value of  $30\mu F$  is calculated using the maximum EEPROM write current and EEPROM write time. This assumes that the  $V_{CC}$  slew rate allows time from EVENT trip point to  $V_{CC}$  at 2.5V on the DS1682 is at least  $t_{EW}$ .

Figure 4 shows the DS1682 in a total time-of-use application with power that can be removed at the same time as the end of the event. In this application, the  $V_{CC}$  slew rate at power-down is slow with respect to  $t_{EW}$ . The external RST IC ends the event as  $V_{CC}$  begins to drop.  $V_{CC}$  must remain above 2.5V until the end of  $t_{EW}$ .

Figure 3. Total Time-of-Use Application with Fast V<sub>CC</sub> Slew Rate

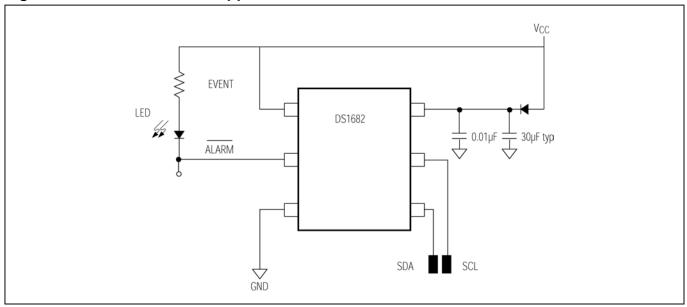


Figure 4. Total Time-of-Use Application with Slow V<sub>CC</sub> Slew Rate

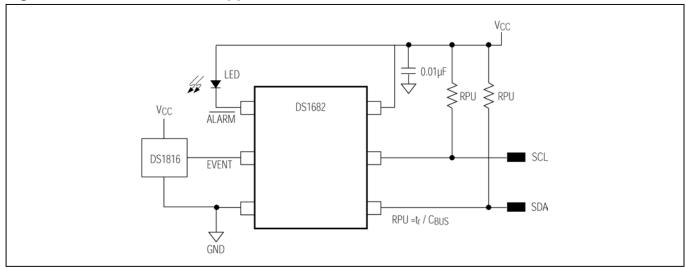
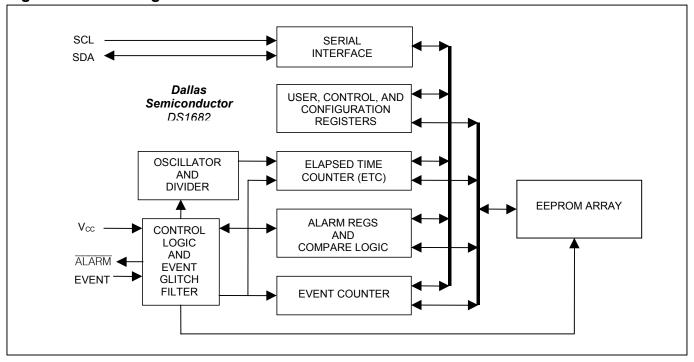


Figure 5. Block Diagram



# PIN DESCRIPTION

PIN	NAME	FUNCTION
1	EVENT	(Event Input) – The EVENT pin is the input the DS1682 monitors to determine when an event occurs. When the pin is pulled high, the contents of the EEPROM are transferred to the ETC and the oscillator starts. The ETC begins to count in quarter-second increments. When the EVENT pin falls to logic 0, the event counter increments, and the event counter, ETC, and user-memory data are stored in the EEPROM array. When the EVENT pin changes states, the 2-wire bus is unavailable for communications for $t_{\rm EW}$ (falling) and $t_{\rm ER}$ (rising). The EVENT input is also deglitched ( $t_{\rm G}$ ) to prevent short noise spikes from triggering an event.
2, 7	N.C.	No Connect. This pin is not connected internally.
3	ALARM	Alarm Output. The DS1682 monitors the values in the ETC for the programmed value in the alarm register. When the ETC matches the alarm value, the alarm flag (AF) is set. Once set, the alarm flag cannot be reset. See the operating descriptions for the AOS and AP bits for details about the operation of the ALARM pin.
4	GND	Ground
5	SCL	2-Wire Serial-Clock Input. The SCL pin is the serial-clock input for the 2-wire synchronous communications channel. The SCL pin is an input that requires an external pullup resistor.
6	SDA	2-Wire Input/Output. The SDA pin is the data input/output signal for the 2-wire synchronous communications channel. The SDA pin is an open-drain I/O, which requires an external pullup resistor.
8	V <sub>cc</sub>	+2.5V to +5.5V input supply

## **OPERATION**

The block diagram in Figure 5 shows the relationship between the major functional blocks, the serial interface, and the EEPROM memory section of the DS1682. Upon power-up, the DS1682 transfers the contents of the EEPROM into the counters and memory registers where the data can be read and written through the serial interface. The

content of the counters and memory registers are written into the EEPROM memory when the EVENT pin transitions from a logic high to a logic low.

The DS1682 uses a calibrated, temperature-compensated RC time base to increment an ETC while an event is active. When the event becomes active, the contents of the nonvolatile EEPROM are transferred to the ETC and event counter and the oscillator starts. As the event continues, the ETC is incremented in quarter-second increments. When the event becomes inactive, the event counter is incremented and the contents of the ETC and event counter are written to the nonvolatile EEPROM.

The ALARM output can be used to indicate when the ETC has matched the value in the alarm register.

The DS1682 can be configured to prevent clearing the alarm and the elapsed time and event counters. The user memory can be separately write-protected.

User-modified data is not stored in EEPROM until an event becomes inactive.

Table 1. Memory Map

ADDR	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	FUNCTION
00	0	AF	WDF	WMDF	AOS	RE	AP	ECMSB	Configuration Register
01				Low	Byte				
02				Low-Mid					Alarm Register
03				High-Mid	ldle Byte				Alaini Negistei
04				High					
05				Low					
06				Low-Mid					Elapsed Time
07				High-Mid	ldle Byte				Counter (ETC)
80				High					
09				Low					Event
0A				High					Counter
0B				Byt					
0C				Byt					
0D				Byt					
0E				Byt					
0F				Byt					User Memory
10				Byt					Good Moniory
11				Byt					
12				Byt					
13				Byt					
14				Byte	9 10				
15									
16									
17									
18				Not Used (	reads 00h)	)			Not Used
19				`	,				
1A									
1B									
1C 1D				Reset Co	nmand				Reset Command
1E				Write D					Write Disable
1F			,						
1				Write Memo	ory disable	;			Memory Disable

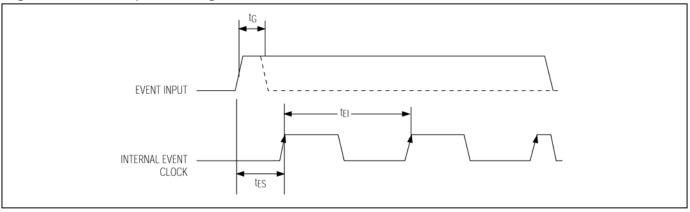
### **EVENT LOGGING**

When the DS1682 is powered up, the event time and count values recorded in the EEPROM are transferred to the ETC and event counter, and the device waits for an event. When an event triggers the input by transitioning the EVENT pin from a low to a high level, the following occurs:

- 1) The RC oscillator starts.
- 2) The alarm, ETC, and event counter are transferred from EEPROM to RAM. **Note:** Reading the RAM during the transfer results in invalid data.
- 3) After  $t_{ES}$ , the ETC increments. An event greater than  $t_{G}$  but less than  $t_{ES}$  increments the event counter but not the ETC (zero-length event).
- 4) The ETC increments every TEI. The ETC holds time in quarter-second resolution.
- 5) When the EVENT pin goes low, the event counter increments, the oscillator stops, and the ETC and event counter are transferred to EEPROM. The 2-wire bus is not available for t<sub>EW</sub>.

The ETC stops counting and does not roll over once FFFFFFFh, or approximately 34 years, is reached. See Figure 6 for timing.

Figure 6. Event Input Timing



#### **DEVICE SETUP**

Once installed in a system, the DS1682 can be programmed to record events as required by the application, and can be tested by generating events and monitoring the results. Afterwards, it can be "locked" to prevent alteration of the event and alarm registers and the alarm condition.

The following is a typical sequence:

- 1) Write the configuration register, alarm registers, and user memory to the desired values.
- 2) Write-protect the alarm, ETC, and event counter registers with the write disable command if needed.
- 3) Write-protect the user memory with the write-memory-disable command, if needed.
- 4) Issue a reset (described in the Reset Command section).

The alarm, ETC and event counter registers, and user memory, once locked, cannot be changed.

Upon reset, the ETC and event counter registers are cleared. The device clears the RE bit, and the configuration register becomes read-only. Additional resets are ignored.

#### **ALARM**

The alarm register is a 32-bit register that holds time in quarter-second resolution. When a nonzero number is programmed into the alarm register, the  $\overline{\text{ALARM}}$  function is enabled and the DS1682 monitors the values in the ETC for the programmed value in the alarm register. When the ETC matches the alarm value, the alarm flag is set.

#### **EEPROM ARRAY**

When power is applied, the contents of the EEPROM are transferred to the configuration register, alarm register, ETC, event counter, and user memory. When the event pin goes low,  $V_{CC}$  must remain above  $V_{CC}$  minimum for  $t_{EW}$  to ensure the EEPROM is properly written.

The EEPROM array for the ETC and the event counter is made up of three banks. Each bank can be written a maximum of 50k times. The device switches between banks based upon the value in the event counter. Resetting the event counter before the counter reaches 50,000 will cause additional writes to the first bank, which can allow writes in excess of 50k. If the event counter is set to greater than 50k or 100k prior to reset, the device stays on the selected bank. This could result in writes in excess of 50k to one bank.

The configuration and alarm registers and the user memory are held in one bank of EEPROM. Writes at the end of an event only occur if the data has changed in one or more of those registers.

User-modified data in any of the registers is stored in EEPROM only if the data was written while an event was active and is stored when the event ends.

## **EVENT COUNTER REGISTER**

This 17-bit event counter register set provides the total number of data samples logged during the life of the product up to 131,072 separate events. The event counter consists of 2 bytes of memory in the memory map plus the event counter MSB bit (ECMSB) in the configuration register. Once the event counter reaches 1FFFFh, event counting stops.

## **RESET COMMAND**

If RE is set to a 1, a reset occurs when a reset command is sent through the 2-wire bus. A reset command is issued by writing 55h twice into memory location 1Dh. The writes need not be consecutive. Cycling power on  $V_{CC}$  prior to the second write terminates the reset sequence.

Upon reset, the ETC and event counter registers are cleared. The AF, RE, and ECMSB bits are cleared by the device, and the configuration register becomes read-only. The data are written to the EEPROM, and additional resets are ignored.

When a reset command is issued, no additional command should be issued during the EEPROM write time (t<sub>EW</sub>).

#### **CONFIGURATION REGISTER**

MSB							LSB
0	AF	WDF	WMDF	AOS	RE	AP	ECMSB

**Note:** The configuration register is not stored in EEPROM until an event becomes inactive. RE does not need to be stored in EEPROM to reset the device.

**Alarm Flag (AF).** The alarm flag is set to a 1 when the ETC value matches the alarm register. Once the AF bit is set to a 1, it cannot be set to a 0. This bit is read-only.

Write Disable Flag (WDF). When the write disable command is written to AAh twice at memory location 1Eh, the WDF is set to a 1 and cannot be cleared or reset. When WDF is set to a 1, the alarm, ETC, and event counter registers are read-only. This bit is read-only. The writes need not be consecutive. Cycling power on  $V_{CC}$  prior to the second write terminates the reset sequence.

**Write-Memory-Disable Flag (WMDF).** When the write-memory-disable command is written to F0h twice at memory location 1Fh, the WMDF is set to a 1 and cannot be reset or cleared. Once the WMDF is set to a 1, the 10-byte user memory becomes read-only. This bit is read-only. The writes need not be consecutive. Cycling power on  $V_{CC}$  prior to the second write terminates the reset sequence.

Alarm Output Select (AOS). If AOS is 0 and AF is true, the DS1682 activates the  $\overline{\text{ALARM}}$  output during an event when AF becomes true. The DS1682 also activates the  $\overline{\text{ALARM}}$  output by pulling the pin low four times at power-up, at the start and end of an event, or when the  $\overline{\text{ALARM}}$  pin is pulled low and released. This output mode can be used to flash an LED or to communicate with another device to indicate that an alarm has occurred. AP has no affect on the output when AOS is 0.

If AOS is a 1 and AF is true, the  $\overline{\text{ALARM}}$  output is constant when the alarm is active. AP determines the polarity of the output.

**Reset Enable (RE).** The reset enable bit allows the device to be reset by enabling the reset command. The sections of the DS1682 that are reset are then dependent on the value in the WDF. With the WDF set to 0 and the reset enable bit set to a 1, the reset command clears the ETC, EEPROM, and event counter. When the reset enable bit is set to a 0, the reset command is disabled.

Alarm Polarity (AP). When the alarm polarity bit in the configuration register is set to 0, the  $\overline{ALARM}$  output is high impedance during the period that the value in the ETC is less than the alarm register value. When the ETC matches the alarm value, the  $\overline{ALARM}$  pin is driven low. If the AP bit is set to a 1, the  $\overline{ALARM}$  output is driven low during the period that the ETC is less than the alarm value. When the ETC matches the alarm value, the  $\overline{ALARM}$  pin becomes high impedance. The AP bit has no affect if AOS is set to a 0.

Event Counter MSB (ECMSB). This bit is read-only.

#### **USER MEMORY**

There are 10 bytes of user-programmable, EEPROM memory. Once the write-memory disable flag is set to 1, the memory becomes read-only. User memory is not stored in EEPROM until an event becomes inactive.

## 2-WIRE SERIAL DATA BUS

The DS1682 supports a bidirectional, 2-wire bus and data-transmission protocol. A device that sends data onto the bus is defined as a transmitter and a device receiving data, a receiver. The device that controls the message is called a master, and the devices controlled by the master are slaves. A master device that generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions must control the bus. The DS1682 operates as a slave on the 2-wire bus. Connections to the bus are made through the open-drain I/O lines SDA and SCL.

The following bus protocol has been defined (Figure 7):

- Data transfer can be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high. Changes in the data line while the clock line is high are interpreted as control signals.

Accordingly, the following bus conditions have been defined:

**Bus Not Busy**: Both data and clock lines remain high.

**Start Data Transfer**: A change in the state of the data line, from high to low, while the clock is high, defines a START condition.

**Stop Data Transfer**: A change in the state of the data line, from low to high, while the clock line is high, defines the STOP condition.

**Data Valid**: The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the high period of the clock signal. The data on the line must be changed during the low period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of data bytes transferred between START and STOP conditions are not limited, and are determined by the master device.

The information is transferred byte-wise and each receiver acknowledges with a ninth bit. Within the bus specifications a standard mode (100kHz clock rate) and a fast mode (400kHz clock rate) are defined.

**Acknowledge**: Each receiving device, when addressed, is obliged to generate an acknowledge after it receives each byte. The master device must generate an extra clock pulse, which is associated with this acknowledge bit.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable low during the high period of the acknowledge-related clock pulse. Of course, setup and hold times must be considered. A master must signal an end-of-data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line high to enable the master to generate the STOP condition.

Depending upon the state of the  $R/\overline{W}$  bit, two types of data transfer are possible:

**Data transfer from a master transmitter to a slave receiver.** The first byte transmitted by the master is the slave address. Next follows a number of data bytes. The slave returns an acknowledge bit after each received byte.

**Data transfer from a slave transmitter to a master receiver.** The master transmits the first byte (the slave address). The slave then returns an acknowledge bit. Next follows a number of data bytes transmitted by the slave to the master. The master returns an acknowledge bit after all received bytes other than the last byte. A "not acknowledge" is returned at the end of the last received byte.

The master device generates all of the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a repeated START condition. Since a repeated START condition is also the beginning of the next serial transfer, the bus is not released.

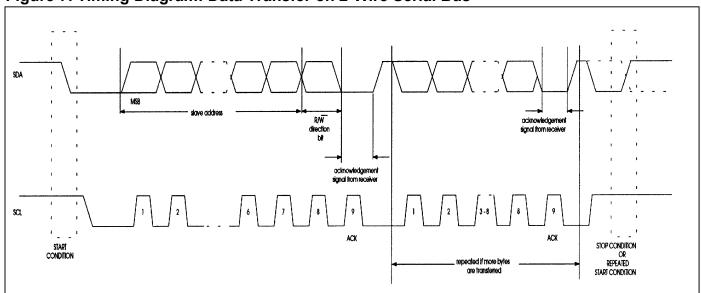


Figure 7. Timing Diagram: Data Transfer on 2-Wire Serial Bus

The DS1682 can operate in the following two modes:

Slave Receiver Mode (Write Mode): Serial data and clock are received through SDA and SCL. After each byte is received, the receiver transmits an acknowledge bit. START and STOP conditions are recognized as the beginning and end of a serial transfer. The slave address byte is the first byte received after the master generates a START condition. The address byte contains the 7-bit DS1682 address, which is 1101011, followed by the direction bit  $(R\overline{NW})$ . The second byte from the master is the register address. This sets the register pointer. The master then transmits each byte of data, with the DS1682 acknowledging each byte received. The register pointer increments after each byte is written. The master generates a STOP condition to terminate the data write (Figure 8).

Slave Transmitter Mode (Read Mode): The first byte is received and handled as in the slave receiver mode. However, in this mode, the direction bit indicates that the transfer direction is reversed. Serial data is transmitted on SDA by the DS1682 while the serial clock is input on SCL. The slave address byte is the first byte received after the master generates a START condition. The address byte contains the 7-bit DS1682 address, followed by the direction bit ( $R/\overline{W}$ ). After receiving a valid slave address byte and direction bit, the DS1682 generates an acknowledge on the SDA line. The DS1682 begins to transmit data on each SCL pulse starting with the register address pointed to by the register pointer. As the master reads each byte, it must generate an acknowledge. The register pointer increments after each byte is read. The DS1682 must receive a "not acknowledge" on the last byte to end a read (Figure 9).

Figure 8. Data Write—Slave Receiver Mode

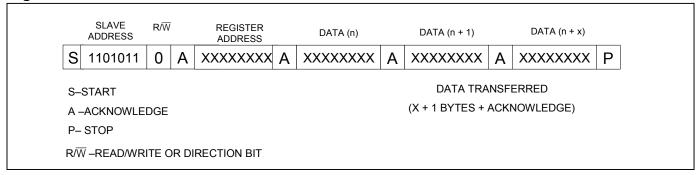


Figure 9. Data Read—Slave Transmitter Mode

SLAVE ADDRESS	R/W		DATA (n)		DATA (n + 1)		DATA (n + 2)		DATA (n + x)	
S 1101011	1	Α	XXXXXXX	Α	XXXXXXX	Α	XXXXXXX	Α	XXXXXXX	/A
S—START A— ACKNOWI P— STOP		_					DATA TRAN (X + 1 BYTES + A			
$/A$ — NOT ACK $R/\overline{W}$ — READ/ $/$			JE DIRECTION BIT	-						

#### CHIP INFORMATION

TRANSISTOR COUNT: 26,032

PROCESS: CMOS

#### PACKAGE INFORMATION

(For the latest package information, go to www.maxim-ic.com/packages.)